

Features

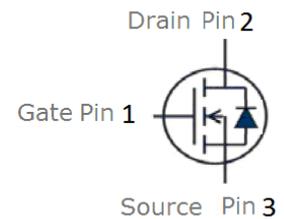
- N-Channel, 10V Logic Level Control
- Enhancement mode
- Low on-resistance $R_{DS(on)}$ @ $V_{GS}=10\text{ V}$
- Fast Switching
- Pb-free lead plating; RoHS compliant


Halogen-Free

| Part ID | Package Type | Marking | Tape and reel information |
|----------|--------------|---------|---------------------------|
| VS4N55AI | TO-251SL | 4N55AI | 75pcs/Tube |

| | | |
|---------------------------------------|-----|----------|
| V_{DS} | 550 | V |
| $R_{DS(on),TYP} @ V_{GS}=10\text{ V}$ | 2.1 | Ω |
| I_D | 4 | A |

TO-251SL



Maximum ratings, at $T_A = 25^\circ\text{C}$, unless otherwise specified

| Symbol | Parameter | Rating | Unit |
|----------------|--|---------------------------|------------------|
| $V_{(BR)DSS}$ | Drain-Source breakdown voltage | 550 | V |
| V_{GS} | Gate-Source voltage | ± 30 | V |
| I_S | Diode continuous forward current | $T_C = 25^\circ\text{C}$ | 4 A |
| I_D | Continuous drain current @ $V_{GS}=10\text{V}$ | $T_C = 25^\circ\text{C}$ | 4 A |
| | | $T_C = 100^\circ\text{C}$ | 2.5 A |
| I_{DM} | Pulse drain current tested ① | $T_C = 25^\circ\text{C}$ | 16 A |
| I_{DSM} | Continuous drain current @ $V_{GS}=10\text{V}$ | $T_A = 25^\circ\text{C}$ | 0.5 A |
| | | $T_A = 70^\circ\text{C}$ | 0.4 A |
| EAS | Avalanche energy, single pulsed ② | 35 | mJ |
| P_D | Maximum power dissipation | $T_C = 25^\circ\text{C}$ | 63 W |
| P_{DSM} | Maximum power dissipation ③ | $T_A = 25^\circ\text{C}$ | 1.25 W |
| T_{STG}, T_J | Storage and Junction Temperature Range | -55 to 150 | $^\circ\text{C}$ |

Thermal Characteristics

| Symbol | Parameter | Typical | Unit |
|-----------------|---|---------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | 2 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 100 | $^\circ\text{C/W}$ |

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Unit |
|---|---|---|------|------|------|------|
| Static Electrical Characteristics @ T_j=25°C (unless otherwise stated) | | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =250μA | 550 | 593 | -- | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =550V, V _{GS} =0V | -- | -- | 1 | μA |
| | Zero Gate Voltage Drain Current (T _j =125°C) | V _{DS} =440V, V _{GS} =0V | -- | -- | 50 | μA |
| I _{GSS} | Gate-Body Leakage Current | V _{GS} =±30V, V _{DS} =0V | -- | -- | ±100 | nA |
| V _{GS(TH)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250μA | 2.4 | 3 | 3.6 | V |
| R _{DS(ON)} | Drain-Source On-State Resistance ④ | V _{GS} =10V, I _D =2A | -- | 2.1 | 2.7 | Ω |
| Dynamic Electrical Characteristics @ T_j = 25°C (unless otherwise stated) | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} =30V, V _{GS} =0V, f=1MHz | 290 | 370 | 450 | pF |
| C _{oss} | Output Capacitance | | 25 | 40 | 55 | pF |
| C _{rss} | Reverse Transfer Capacitance | | -- | 6 | 10 | pF |
| R _g | Gate Resistance | f=1MHz | -- | 2 | -- | Ω |
| Q _g | Total Gate Charge | V _{DS} =440V, I _D =4A, V _{GS} =10V | -- | 13 | -- | nC |
| Q _{gs} | Gate-Source Charge | | -- | 4.7 | -- | nC |
| Q _{gd} | Gate-Drain Charge | | -- | 5.8 | -- | nC |
| Switching Characteristics | | | | | | |
| t _{d(on)} | Turn-on Delay Time | V _{DD} =250V, I _D =4A, R _G =25Ω, V _{GS} =10V | -- | 20 | -- | ns |
| t _r | Turn-on Rise Time | | -- | 35 | -- | ns |
| t _{d(off)} | Turn-Off Delay Time | | -- | 33 | -- | ns |
| t _f | Turn-Off Fall Time | | -- | 28 | -- | ns |
| Source- Drain Diode Characteristics @ T_j = 25°C (unless otherwise stated) | | | | | | |
| V _{SD} | Forward on voltage | I _{SD} =4A, V _{GS} =0V | -- | 0.9 | 1.2 | V |
| t _{rr} | Reverse Recovery Time | T _j =25°C, I _{sd} =4A, V _{GS} =0V | -- | 89 | -- | ns |
| Q _{rr} | Reverse Recovery Charge | di/dt=100A/μs | -- | 0.2 | -- | μC |

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{Jmax}, starting T_J = 25°C, L = 1mH, R_G = 25Ω, I_{AS} = 8A, V_{GS} = 10V. Part not recommended for use above this value
- ③ The power dissipation P_{DSM} is based on R_{θJA} and the maximum allowed junction temperature of 150°C.
- ④ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

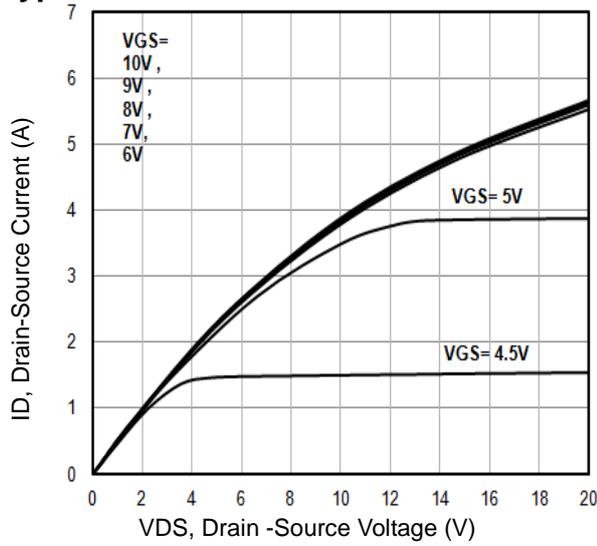


Fig1. Typical Output Characteristics

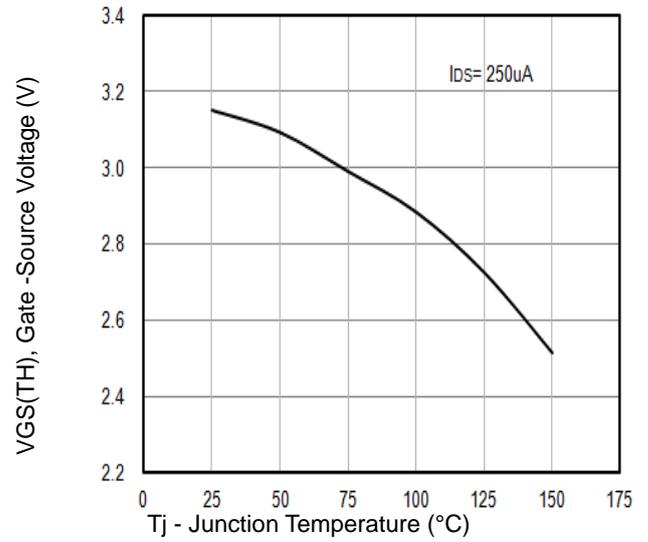


Fig2. $V_{GS(TH)}$ Gate-Source Voltage Vs. T_j

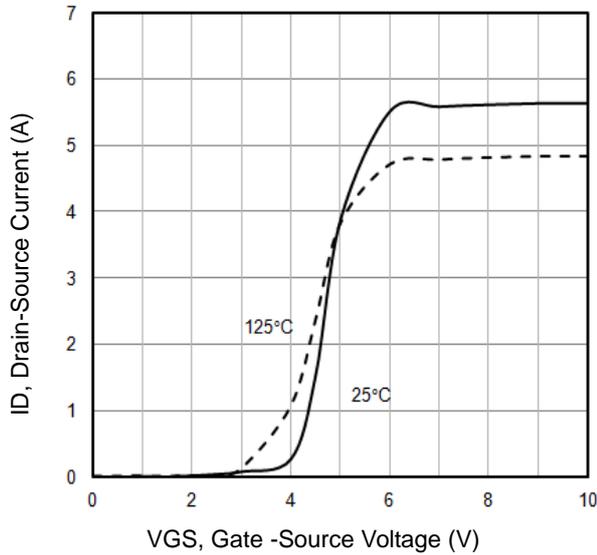


Fig3. Typical Transfer Characteristics

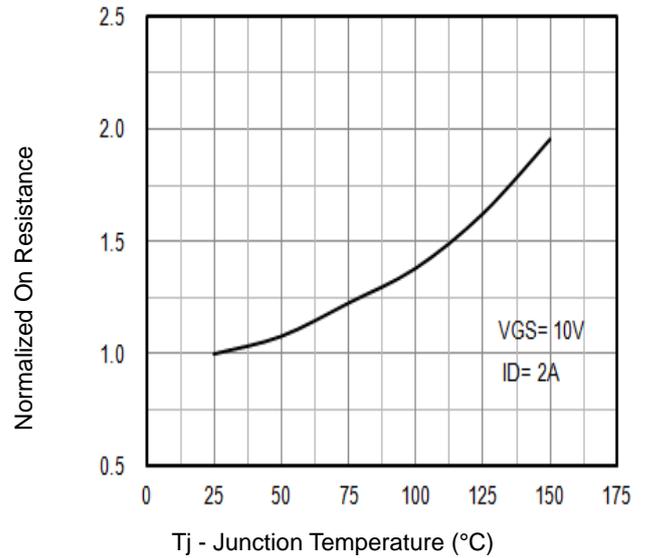


Fig4. Normalized On-Resistance Vs. T_j

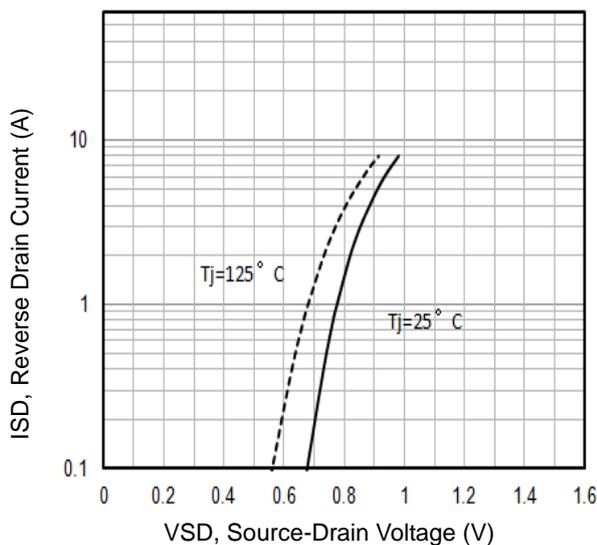


Fig5. Typical Source-Drain Diode Forward Voltage

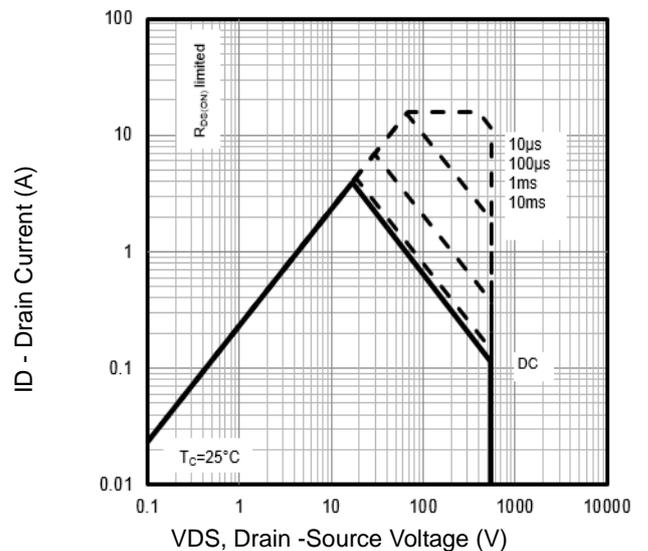


Fig6. Maximum Safe Operating Area

Typical Characteristics

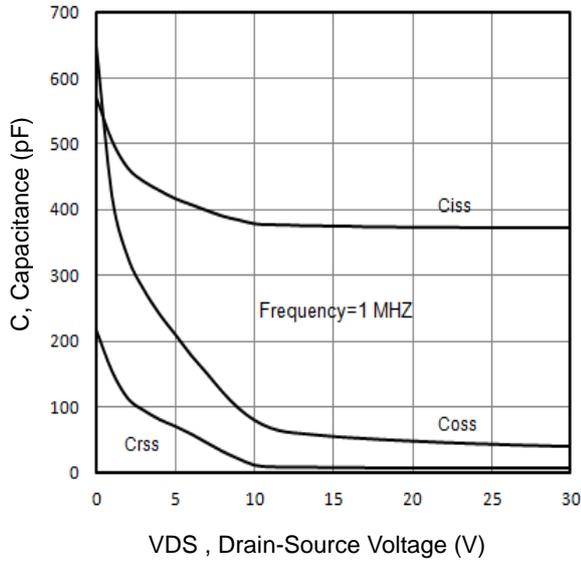


Fig7. Typical Capacitance Vs.Drain-Source Voltage

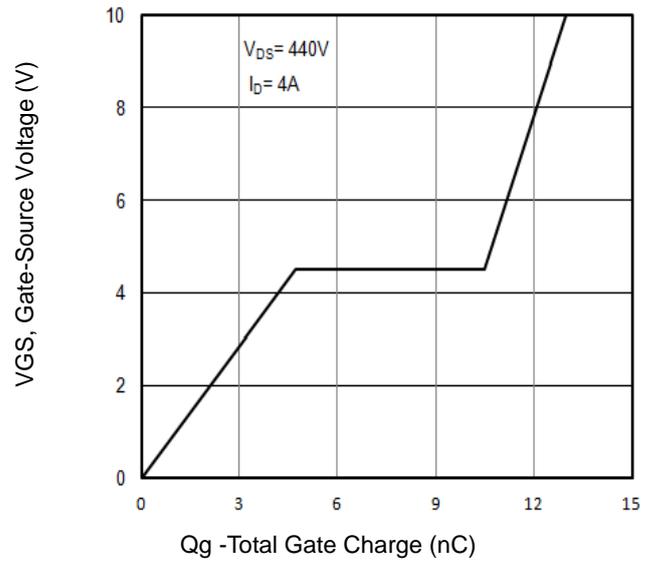


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

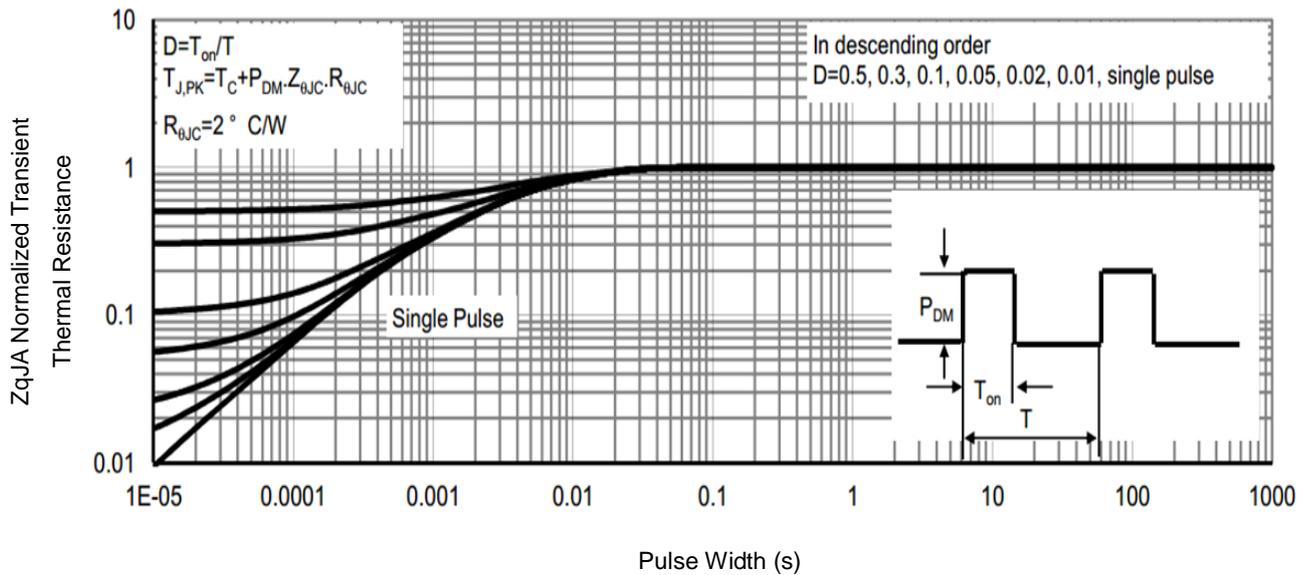


Fig9. Normalized Maximum Transient Thermal Impedance

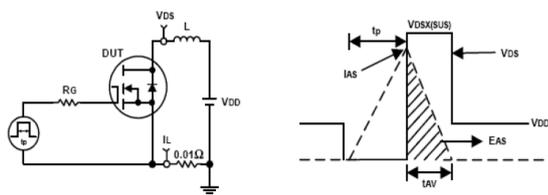


Fig10. Unclamped Inductive Test Circuit and waveforms

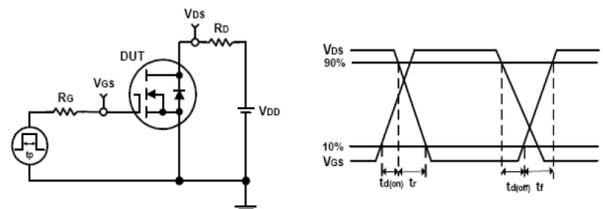
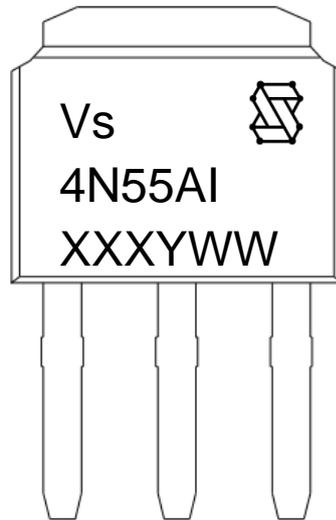


Fig11. Switching Time Test Circuit and waveforms



Marking Information



1st line: Vanguard Code (Vs), Vanguard Logo

2nd line: Part Number (4N55AI)

3rd line: Date code (XXXYWW)

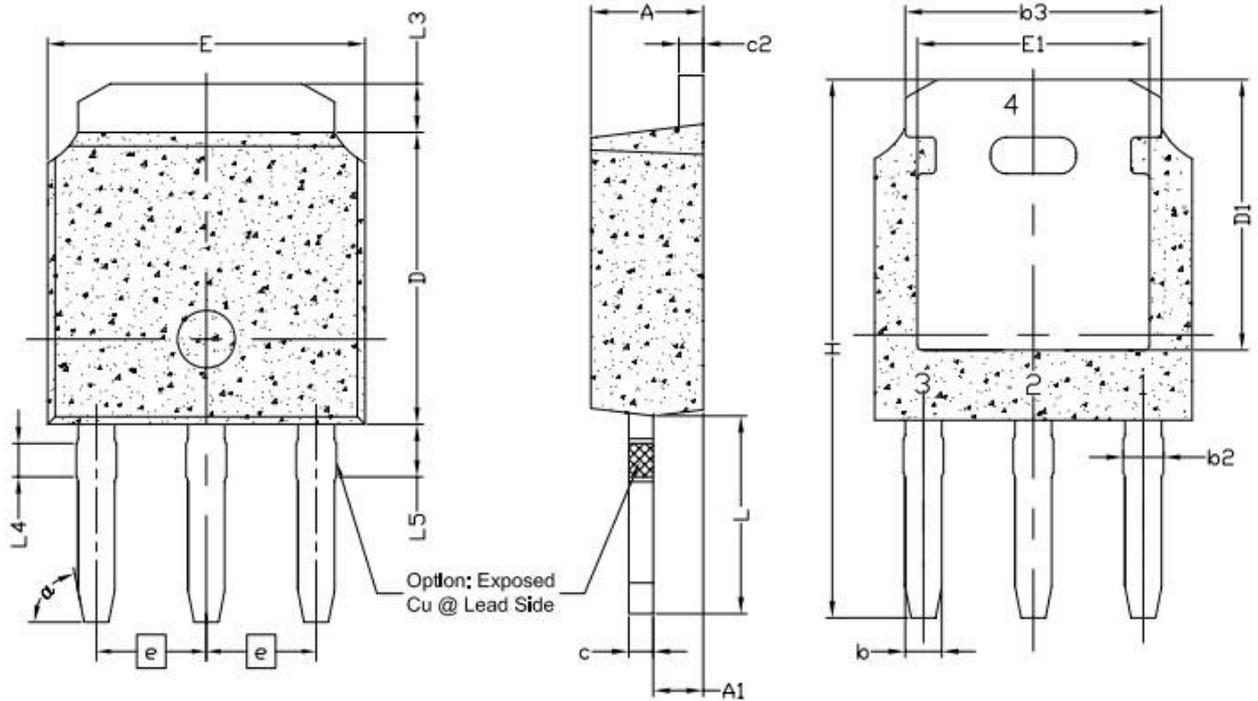
XXX: Wafer Lot Number

Y: Year Code, e.g. E means 2017

WW: Week Code



TO-251SL Package Outline Data



| Symbol | Dimensions (unit: mm) | | |
|----------|-----------------------|-------|-------|
| | Min | Typ | Max |
| A | 2.20 | 2.30 | 2.39 |
| A1 | 0.89 | 1.04 | 1.15 |
| b | 0.64 | 0.76 | 0.89 |
| b2 | 0.77 | 0.84 | 1.14 |
| b3 | 5.21 | 5.34 | 5.46 |
| c | 0.46 | 0.50 | 0.60 |
| c2 | 0.46 | 0.50 | 0.60 |
| D | 5.98 | 6.10 | 6.223 |
| D1 | 5.10 | -- | -- |
| E | 6.40 | 6.60 | 6.731 |
| E1 | 4.40 | -- | -- |
| e | 2.286 BSC | | |
| H | 11.05 | 11.25 | 11.45 |
| L | 3.98 | 4.13 | 4.35 |
| L3 | 0.89 | -- | 1.27 |
| L4 | 0.698 REF | | |
| L5 | 0.972 | 1.099 | 1.226 |
| α | 79° REF | | |

Notes:

1. Dimension "D" and "E" do NOT include mold flash, protrusion or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 0.1mm per side.

Customer Service

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